



Material Content Data Sheet



Sales Product Name				IGP30N60H3		Issued		20. July 2018	
MA#				MA001634338					
Package				PG-TO220-3-1		Weight*		2030.93 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	3.012	0.15	0.15	1483	1483	
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		121		
	non noble metal	iron	7439-89-6	0.816	0.04		402		
	non noble metal	copper	7440-50-8	815.335	40.15	40.20	401458	401981	
	non noble metal	aluminium	7429-90-5	2.945	0.14	0.14	1450	1450	
wire	non noble metal	aluminium	7429-90-5	2.945	0.14	0.14	1450	1450	
encapsulation	organic material	carbon black	1333-86-4	5.945	0.29		2927		
	plastics	epoxy resin	-	112.950	5.56		55615		
	inorganic material	silicondioxide	60676-86-0	475.579	23.42	29.27	234168	292710	
leadfinish	non noble metal	tin	7440-31-5	21.462	1.06	1.06	10568	10568	
plating	inorganic material	phosphorus	7723-14-0	0.001	0.00		1		
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	120	121	
solder	non noble metal	antimony	7440-36-0	0.216	0.01		106		
	noble metal	silver	7440-22-4	0.540	0.03		266		
	non noble metal	tin	7440-31-5	1.405	0.07	0.11	692	1064	
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87		
	non noble metal	iron	7439-89-6	0.590	0.03		291		
	non noble metal	copper	7440-50-8	589.466	29.02	29.06	290245	290623	
*deviation	< 10%			Sum in total:		100.00		1000000	

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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